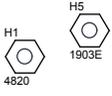


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PCB Number: TIDA_00628
PCB Rev: E1



PCB
LOGO
Texas Instruments

J3
MECH
20020006-H021B01LF
OUTPUT PLUG

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Orderable: N/A	Designed for:	Mod. Date: 18/08/2015
TID #:	Project Title: TIDA_00628	
Number: TIDA_00628	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3
Drawn By:	File: TIDA_00628_Hardware_SchDoc	Size: B
Engineer: Billy Long	Contact: http://www.ti.com/support	



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